

**General Description:**

Using owner proprietary trench design and advanced Field Stop (FS) technology, offering superior conduction and switching performances. RoHS Compliant.

**Features:**

- FS Trench Technology, Positive temperature coefficient
- Low saturation voltage:

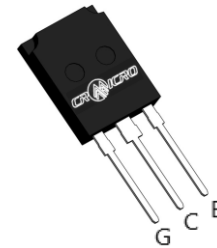
$$V_{CE(sat),TYP}=1.65V @I_C=100A,V_{GE}=15V;$$

**Applications**

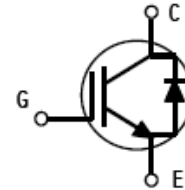
- Solar Inverter
- ESS
- UPS

$V_{CES}$	1200	V
$I_C$	100	A
$P_{tot} (T_C=25^{\circ}C)$	750	W
$V_{CE(sat)}$	1.65	V

Outline : TO-247PLUS



Inner Circuit:



**Package Parameters**

Type	Marking	Package	Packing
CRG100T120BX5HDZ	G100T120BX5HDZ	TO-247PLUS	Tube

**Absolute Maximum Ratings** ( $T_C=25^{\circ}\text{C}$  unless otherwise specified):

Symbol	Parameter	Rating	Unit
$V_{CES}$	Collector-Emitter Voltage	1200	V
$V_{GES}$	Gate- Emitter Voltage	$\pm 20$	V
$V_{GES}$	Gate- Emitter Voltage ( $t_p \leq 10\mu\text{s}, D < 0.01$ )	$\pm 30$	V
$I_C$	Collector Current @ $T_C = 25^{\circ}\text{C}$	180	A
	Collector Current @ $T_C = 100^{\circ}\text{C}$	100	
$I_{CM}^{a1}$	Pulsed Collector Current	400	A
$I_F$	Diode Continuous Forward Current @ $T_C = 25^{\circ}\text{C}$	200	A
	Diode Continuous Forward Current @ $T_C = 100^{\circ}\text{C}$	100	
$I_{FM}$	Diode Maximum Forward Current	400	A
$P_D$	Power Dissipation @ $T_C = 25^{\circ}\text{C}$	750	W
	Power Dissipation @ $T_C = 100^{\circ}\text{C}$	375	W
$T_{vjop}^{a2}$	Operating Junction temperature range	$-40 \sim 175$	$^{\circ}\text{C}$
$T_{stg}$	Storage Temperature Range	$-55 \sim 150$	$^{\circ}\text{C}$
$T_L$	Maximum Temperature for Soldering	270	$^{\circ}\text{C}$

**Thermal Characteristics**

Symbol	Parameter	Typ.	Max.	Unit
$R\theta_{JC}$	Thermal Resistance, Junction to case for IGBT	--	0.20	$^{\circ}\text{C}/\text{W}$
$R\theta_{JC}$	Thermal Resistance, Junction to case for Diode	--	0.56	$^{\circ}\text{C}/\text{W}$
$R\theta_{JA}$	Thermal Resistance, Junction to Ambient	--	40	$^{\circ}\text{C}/\text{W}$

**Electrical Characteristics of the IGBT** ( $T_C=25^{\circ}\text{C}$  unless otherwise specified):

Symbol	Parameter	Conditions	Value			Unit
			Min.	Typ	Max.	
<b>OFF Characteristics</b>						
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	$V_{GE}=0\text{V}, I_{CE}=250\mu\text{A}$	1200	--	--	V
$I_{CES}$	Collector Cut-off Current	$V_{GE}=0\text{V}, V_{CE}=1200\text{V}$	--	--	1	mA
$I_{GES(F)}$	Gate-Emitter Forward Leakage Current	$V_{GE}=+20\text{V}$	--	--	+250	nA
$I_{GES(R)}$	Gate-Emitter Reverse Leakage Current	$V_{GE}=-20\text{V}$	--	--	-250	nA
<b>ON Characteristics</b>						
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C=100\text{A}, V_{GE}=15\text{V}$ @ $T_C = 25^{\circ}\text{C}$	--	1.65	2.4	V
		$I_C=100\text{A}, V_{GE}=15\text{V}$ @ $T_C = 175^{\circ}\text{C}$	--	2.1	--	V
$V_{GE(th)}$	Gate - Emitter Threshold	$I_C=1.6\text{mA}, V_{CE}=V_{GE}$	4.0	5.4	7.5	V

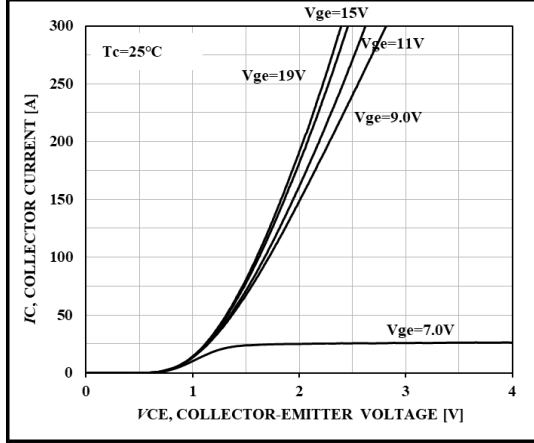
	Voltage					
Pulse width $t_p \leq 300\mu s, \delta \leq 2\%$						
<b>Dynamic Characteristics</b>						
$C_{ies}$	Input Capacitance	$V_{CE}=30V, V_{GE}=0V$ $f=1MHz$	--	14915	--	pF
$C_{oes}$	Output Capacitance		--	224	--	
$C_{res}$	Reverse Transfer Capacitance		--	60	--	
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-on Delay Time	$V_{CE}=600V, I_C=100A,$ $R_g=10\Omega, V_{GE}=15V,$ Inductive Load, $T_J=25^\circ C,$	--	64	--	ns
$t_r$	Rise Time		--	57	--	
$t_{d(off)}$	Turn-Off Delay Time		--	409	--	
$t_f$	Fall Time		--	39	--	
$E_{on}$	Turn-On Switching Loss		--	5.4	--	mJ
$E_{off}$	Turn-Off Switching Loss		--	3.1	--	
$E_{ts}$	Total Switching Loss		--	8.5	--	
$t_{d(on)}$	Turn-on Delay Time	$V_{CE}=600V, I_C=100A,$ $R_g=10\Omega, V_{GE}=15V,$ Inductive Load, $T_J=175^\circ C$	--	51	--	ns
$t_r$	Rise Time		--	68	--	
$t_{d(off)}$	Turn-Off Delay Time		--	493	--	
$t_f$	Fall Time		--	97	--	
$E_{on}$	Turn-On Switching Loss		--	6.4	--	mJ
$E_{off}$	Turn-Off Switching Loss		--	4.9	--	
$E_{ts}$	Total Switching Loss		--	11.3	--	
$Q_g$	Total Gate Charge	$V_{CE}=960V, I_C=100A,$ $V_{GE}=15V,$	--	672	--	nC
$Q_{ge}$	Gate to Emitter Charge		--	94	--	
$Q_{gc}$	Gate to Collector Charge		--	272	--	
<b>Electrical Characteristics of the DIODE</b>						
$V_F$	Diode Forward Voltage	$I_F=100A \quad TC=25^\circ C$	--	2.7	3.2	V
		$I_F=100A \quad TC=175^\circ C$	--	2.3	--	V
$t_{rr}$	Reverse Recovery Time	$I_F=100A$ $di/dt=100A/\mu s$	--	122	--	ns
$I_{rrm}$	Reverse Recovery Current		--	5.2	--	A
$Q_{rr}$	Reverse Recovery Charge		--	317	--	nC

Notes:

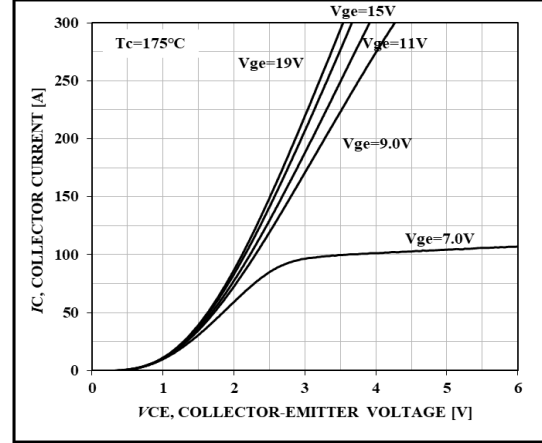
a1: Repetitive rating; pulse width limited by maximum junction temperature

a2: Overload condition, it is allowed to operate under the maximum junction temperature  $T_{vjop} = 175^\circ C$ , the maximum duty cycle is less than 20% (lasting for 60s at most)

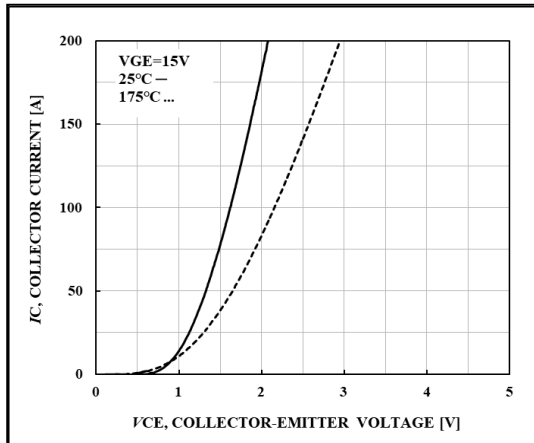
**Typical Performance Characteristics**



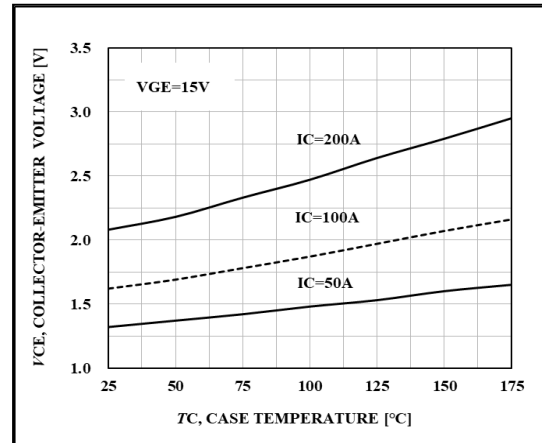
**Figure 1. Output Characteristics**



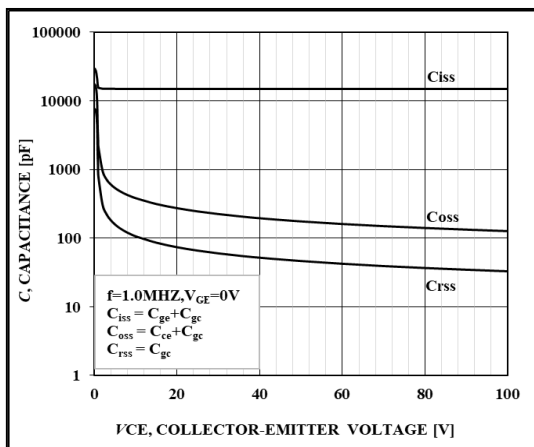
**Figure 2. Output Characteristics**



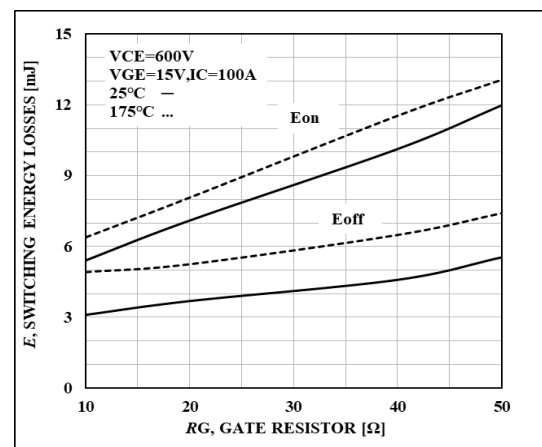
**Figure 3. Saturation Voltage Characteristics**



**Figure 4. Saturation Voltage - $T_C$  Characteristics**



**Figure 5. Capacitance Characteristics**



**Figure 6. Switching Loss- $R_G$  Characteristics**

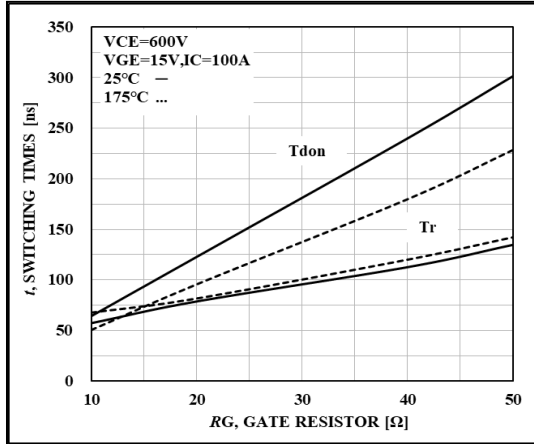


Figure 7. Switching Time- $R_G$  Characteristics

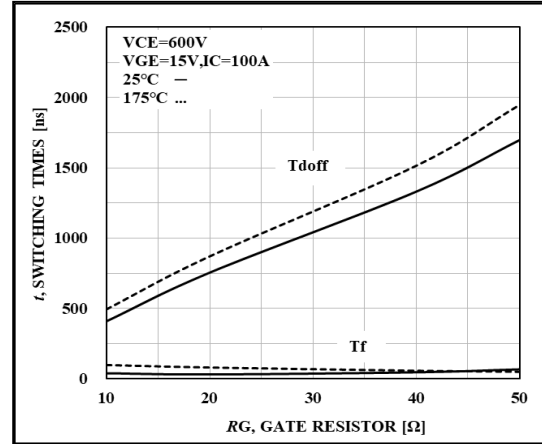


Figure 8. Switching Time- $R_G$  Characteristics

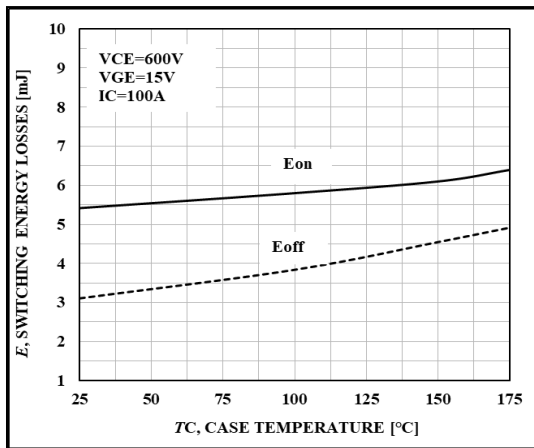


Figure 9. Switching Loss- $T_c$  Characteristics

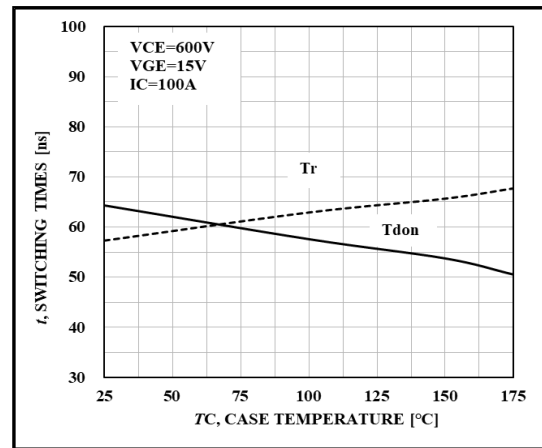


Figure 10. Switching Time- $T_c$  Characteristics

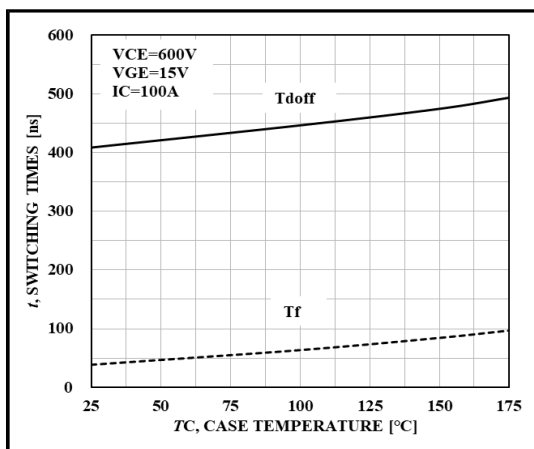


Figure 11. Switching Time- $T_c$  Characteristics

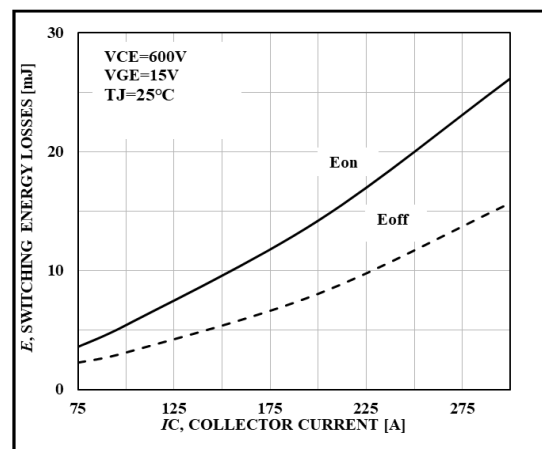


Figure 12. Switching Loss- $I_C$  Characteristics

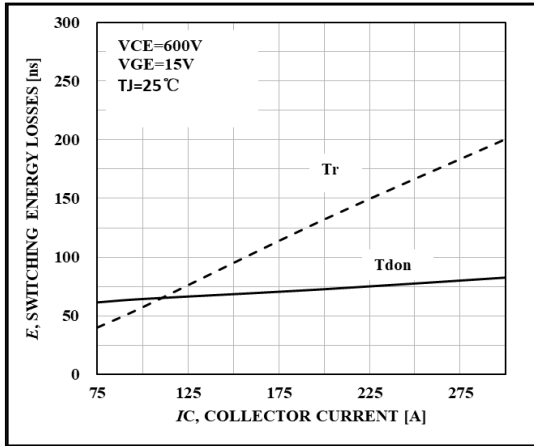


Figure 13. Switching Time- $I_C$  Characteristics

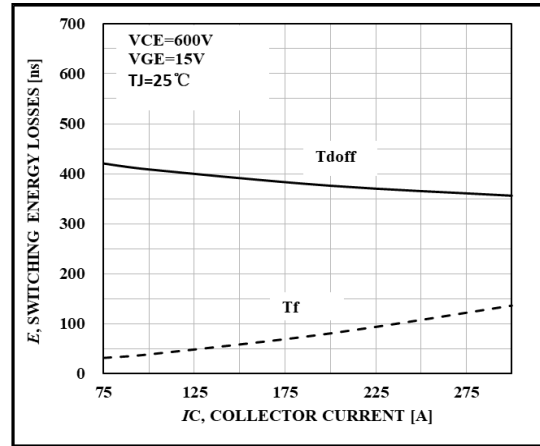


Figure 14. Switching Time- $I_C$  Characteristics

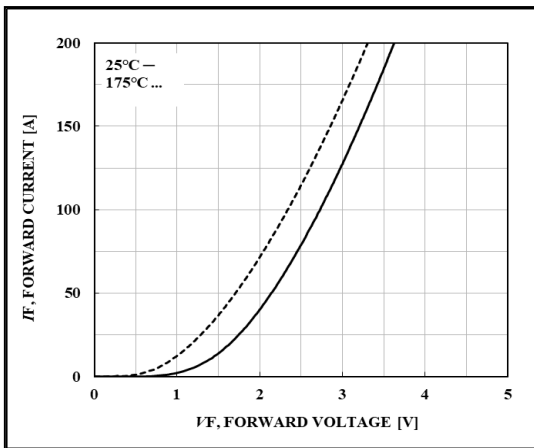


Figure 15. Diode Forward Characteristics

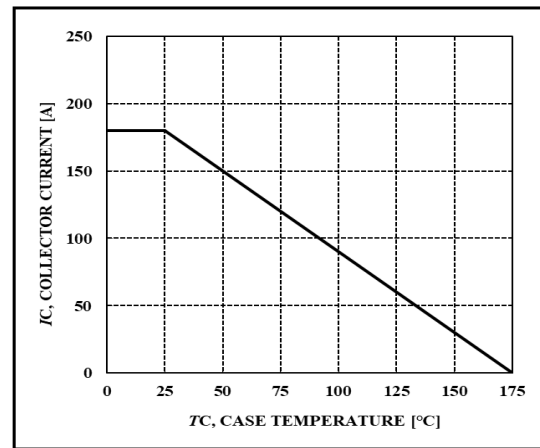


Figure 16. Collector Current- $T_c$  Characteristics  
( $T_j \leq 175^\circ\text{C}$ )

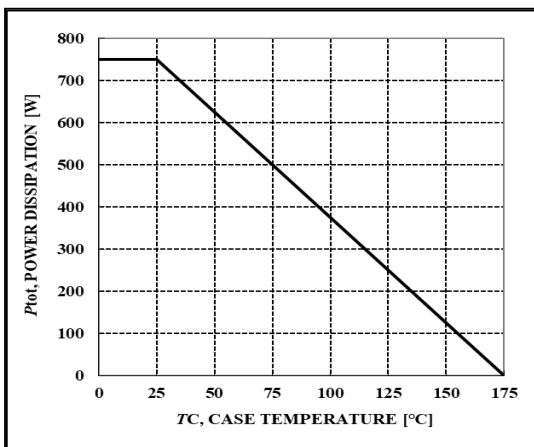


Figure 17. Power Dissipation- $T_c$  Characteristics  
( $T_j \leq 175^\circ\text{C}$ )

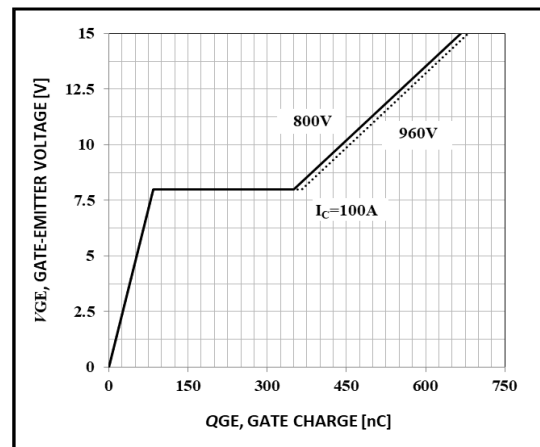


Figure 18. Gate Charge Characteristics

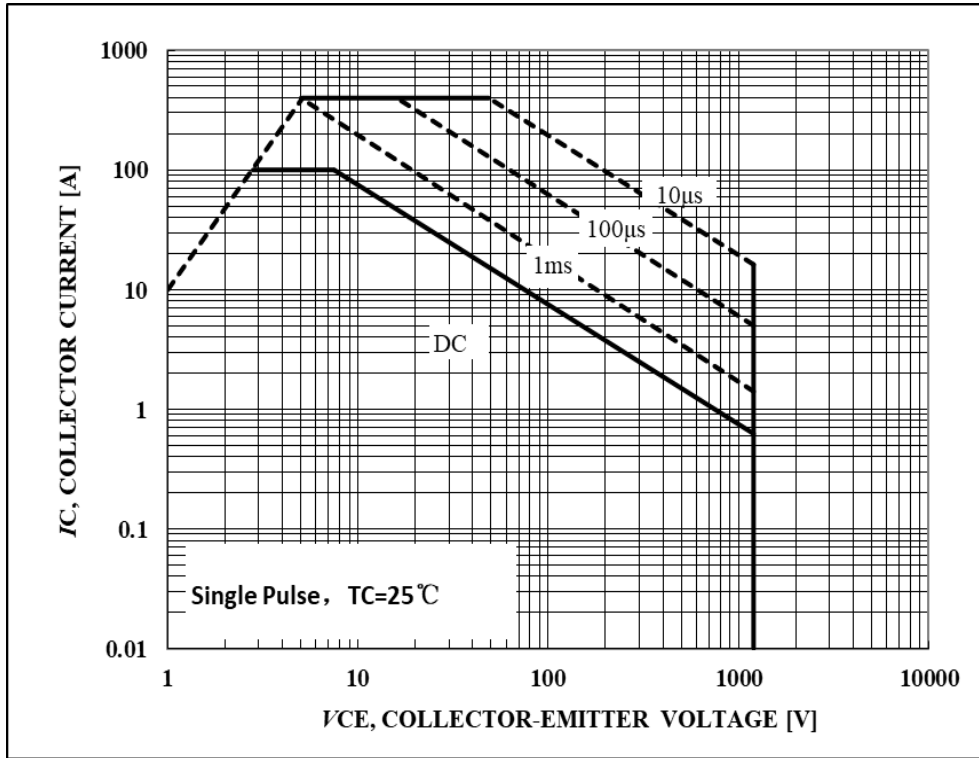


Figure 19. Forward Bias Safe Operating Area

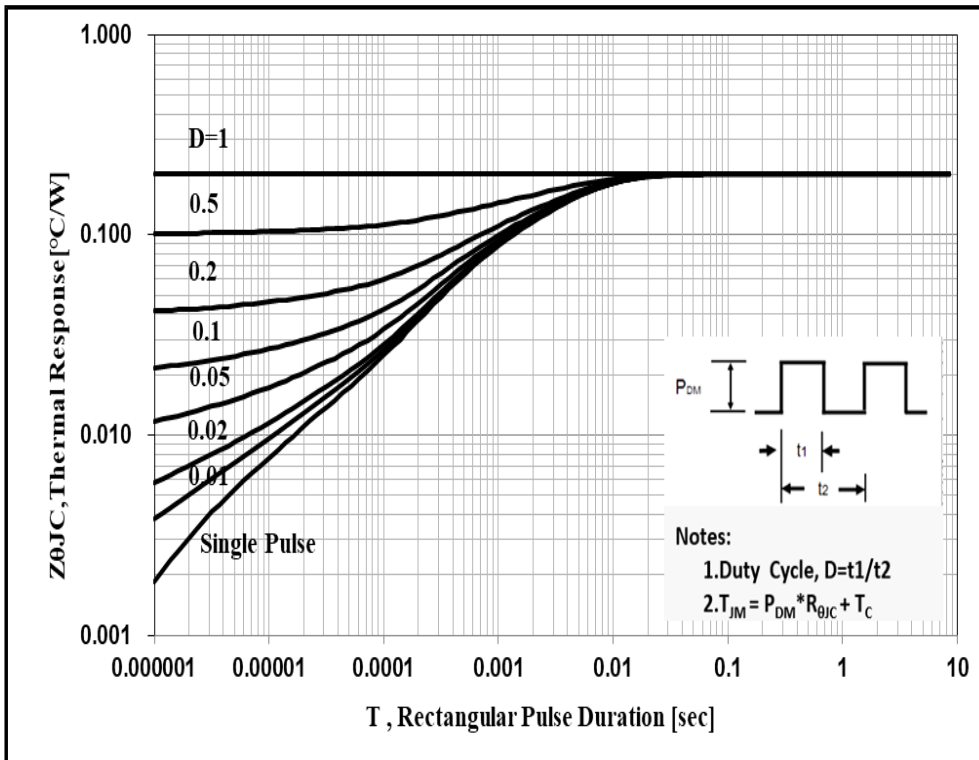
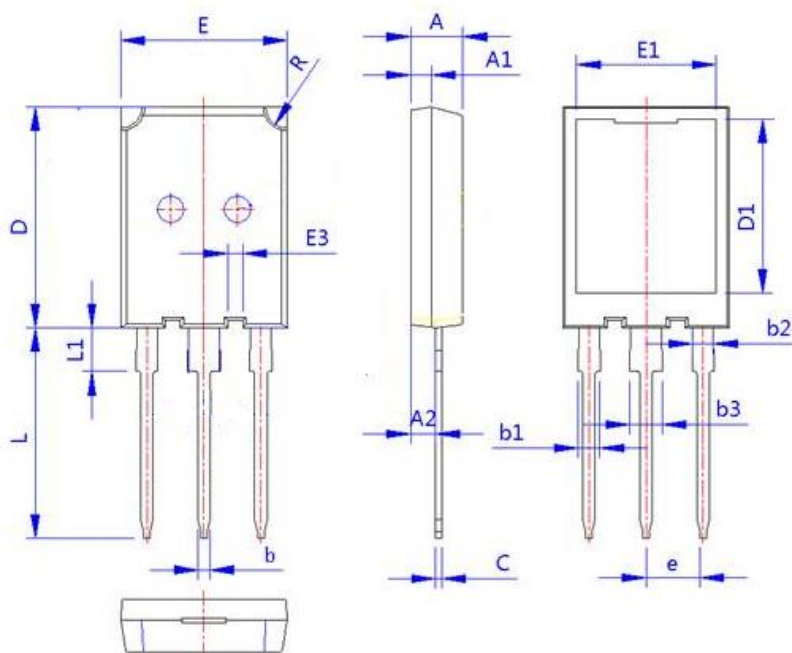


Figure 20. IGBT Transient Thermal Impedance

Package Information



项 目	规范(mm)	
	MIN	MAX
A	4.85	5.15
A1	1.85	2.15
A2	2.15	2.65
b	1.07	1.33
b1	1.90	2.46
b2	1.90	2.16
b3	2.82	3.43
C	0.55	0.70
D	20.75	21.15
D1	16.20	16.90
E	15.50	16.10
E1	13.01	13.51
E3	1.25	1.65
e	5.44 (BSC)	
R	1.80	2.20
L	19.60	20.40
L1	4.00	4.48

TO-247PLUS Package



**The name and content of poisonous and harmful material in products**

Part's Name Limit	Hazardous Substance									
	Pb	Hg	Cd	Cr(VI)	PBB	PBDE	DIBP	DEHP	DBP	BBP
	≤0.1%	≤0.1%	≤0.01%	≤0.1%	≤0.1%	≤0.1%	≤0.1%	≤0.1%	≤0.1%	≤0.1%
Lead Frame	○	○	○	○	○	○	○	○	○	○
Molding	○	○	○	○	○	○	○	○	○	○
Chip	○	○	○	○	○	○	○	○	○	○
Wire Bonding	○	○	○	○	○	○	○	○	○	○
Solder	×	○	○	○	○	○	○	○	○	○
Note	<p>○: Means the hazardous material is under the criterion of 2011/65/EU.                      ×: Means the hazardous material exceeds the criterion of 2011/65/EU.                      The plumbum element of solder exist in products presently, but within the allowed range of Eurogroup's RoHS.</p>									

**Warnings**

1. Exceeding the maximum ratings of the device in performance may cause damage to the device, even the permanent failure, which may affect the dependability of the machine. It is suggested to be used under 80 percent of the maximum ratings of the device.
2. When installing the heat sink, please pay attention to the torsional moment and the smoothness of the heat sink.
3. IGBTs is the device which is sensitive to the static electricity, it is necessary to protect the device from being damaged by the static electricity when using it.
4. This publication is made by Huajing Microelectronics and subject to regular change without notice.

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Modify :

Version	Modify record
2025V01	Initial release